Serial No.: AL181109067-00



PRODUCT TYPE	Quartz Crystal HSX530G
NOMINAL FREQUENCY	8.00000MHz
H.ELE. SAMPLE O/N	EOS-IB0115-9
H.ELE. P/N	X5H008000IK1H-H
RELEASE DATE	2018/11/09
VERSION	00
MSL	Level 1
GREEN PRODUCT	☐ Pb free ☑ RoHS Compliant
	☑ HF-Halogen free ☑ REACH Compliant
CUSTOMER P/N	
APPLICATION & MODEL	
APPROVED BY CUSTOME	R
	(DATE)

Harmony Electronics Corp.	
F. S. TSAI C. C. HOU U. F. CHEN (PREPARE)	Country of Origin: Taiwan Factory Thailand Factory China Factory

HARMONY ELECTRONICS CORPRATION

KAOHSIUNG TAIPEI THAILAND SHENZHEN



REV. No.	DATE	REASON	REVISE CONTENTS
0	2018/11/09	New	

HARMONY ELECTRONICS CORPRATION



Contents

ITEM	PAGE
1. QUARTZ CRYSTAL UNIT SPECIFICATION	3
2. DIMENSIONS	4
3. MARKING	4
4. INSIDE STRUCTURE	5
5. HANDLING SUGGESTIONS	5-6
6. EMBOSS CARRIER TAPE&REEL	6-7
7. PACKAGE	7-8
8. MECHANICAL PERFORMANCE	8-9
9. ENVIRONMENTAL PERFORMANCE	9
10. APPENDIX	

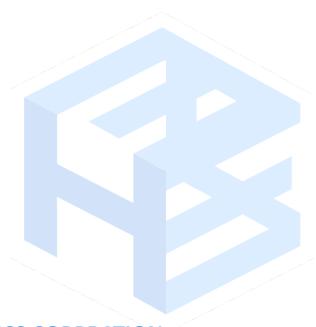
HARMONY ELECTRONICS CORPRATION



1. QUARTZ CRYSTAL UNIT SPECIFICATION

	Ele	ctrical Spe	с.	Unit		
Items	Min	Туре	Max		Notes	
1. Frequency (FL)		8.000000		MHz		
2. Mode of oscillation:	F	undamenta	al			
3. Frequency tolerance	-50		+50	ppm	at 25°C±3°C	
4. Equivalent resistance (RR)			100	Ω	SERIES	
5. Storage temperature range	-40		+85	°C		
6. Operable temperature range	-20		+70	°C		
7. Temperature stability	-50		+50	ppm	-20°C ~ +70°C	
8. Loading capacitance (CL)		20.0		pF		
9. Drive level (DL)		10	300	μW		
10. Shunt Capacitance (CO)			7.0	рF		
11. Insulation resistance	500			МΩ	at DC 100V	
12. Aging:	-5		+5	ppm/Year		
13. Circuit:	Measured in HP/E5100A,S&A 250B					

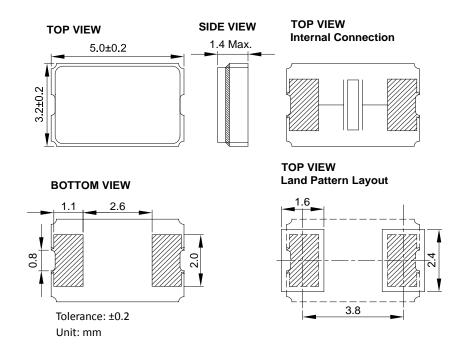
Note: Storage Temperature is only for the product itself.



HARMONY ELECTRONICS CORPRATION

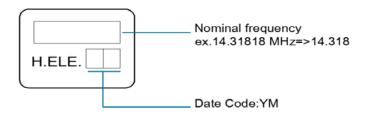


2. DIMENSION



^{*} Note: The Index mark was defined by the BASE suppliers.

3. MARKING



Note:

- 1. Laser marking.
- 2. Date Code:

V V224	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019
Y=Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	0	1	2	3	4	5	6	7	8	9

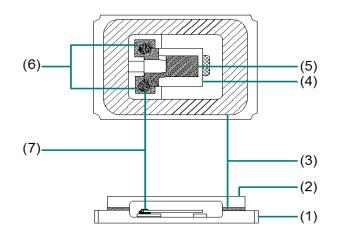
M=Month	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Code	Α	В	С	D	E	F	G	H	J	K	L	М

HARMONY ELECTRONICS CORPRATION

KAOHSIUNG TAIPEI THAILAND SHENZHEN



4. INSIDE STRUCTURE



Reference drawing

No.	Component	Material	Note
(1)	Base- Ceramic	Ceramic	Al ₂ O ₃
(2)	Cap-Ceramic	Ceramic	Al ₂ O ₃
(3)	Crystal-Seal	Glass	-
(4)	Crystal Blank	Quartz	SiO₂ Rectangular At-Cut
(5)	Electrode	Metal	-
(6)	PAD	Metal	W Ni Plating Au Plating
(7)	Connective Adhesive	Silver Powder	Ag

XThe use prohibition chemistry substance of Table 1 of DHE-0204-1 (HE-QA-24) is not included in this item.

5. HANDLING SUGGESTION

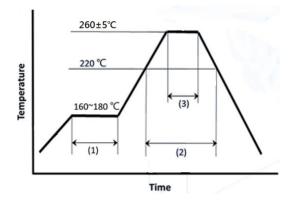
■ Reflow Condition

Please stay with our proposed reflow condition and do soldering within 2 times.

(1)	Preheat	160~18	0deg.C	120 sec.
(2)	Primary heat	>=220	deg.C	100±20 sec.
(3)	Peak	260±5	deg.C	10 sec. Max.

■ Manual Solder iron (Example)

Bit temp.: 350°C max., Time: 3sec max., Each terminal only should be soldered once.



■ Mounting Conditions

Our products are suitable for most automated SMT processes. However, we strongly advise all our customers to conduct SMT sampling prior to mass production in order to make sure production processes will not affect the properties and specifications of our product. Seal welding and mounting procedures involving the use of ultra-sonic processes are not recommended and will affect and/or damage the internal properties of our product. Excessive shock during the mounting process will also affect the product and we strongly recommend setting SMT conditions to minimize such conditions.

If a possibility of the PCB being warped exists we strongly advise to ensure the degree of warping will not affect the product.

Please also ensure the operating characteristics and or soldering conditions are all within the specifications of use for our product.

Ultimately the worst case scenario of all the above will lead to cases of non-oscillation but other negative effects are also likely should our products be used in an inappropriate way. Please note such cases of misuse and its related quality issues are not included in our product warranty.

HARMONY ELECTRONICS CORPRATION

KAOHSIUNG TAIPEI THAILAND SHENZHEN



■ Cleansing Conditions

General cleaning solutions may be used to clean our products but we always recommend testing to be performed prior to mass production processes. Ultrasonic cleaning procedures are not recommended and we strongly advise other forms of cleansing to be evaluated first. Unsuitable cleansing may lead to a number of negative effects such as damage to the product surface, discoloration of the product, corrosion of the package, package contamination, illegible marking, etc. Please note cases of unadvised treatment and its related quality issues are not included in our product warranty.

■ Storage Conditions

Please ensure our products are preserved appropriately in their original packaging. Irregular environmental instances of moisture will affect our product's stability and may cause problems such as frequency instability, soldering ability and conditions, package defects, and other problems. It is essential to keep our products in a clean dust-free environment out of direct sunlight.

Our products' storage conditions should at least meet the following condition:

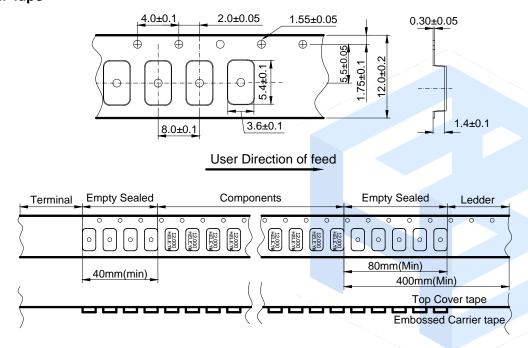
Environmental Temperature: + 40 degrees Celsius Maximum

Relative Humidity: 80% Maximum

Please note storage instances which do not conform to our guidelines and the related quality issues produced as an outcome are not included in our product warranty.

6. EMBOSS CARRIER TAPE AND REEL

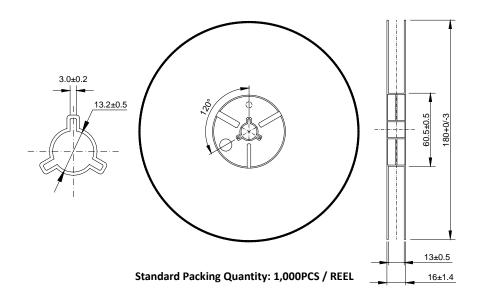
■ Carrier Tape



HARMONY ELECTRONICS CORPRATION



■ Reel



■ Material of The Tape

Таре	Material
Carrier tape	PS Conductive
Top tape	PET

■ Joint of tape

The carrier-tape and top cover-tape should not be jointed.

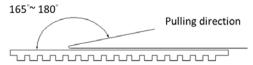
■ Release strength of cover tape

The force should be controlled between 0.1N to 0.7N under following condition.

Pulling direction: 165° to 180°

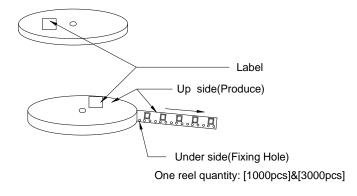
Speed: 300mm/min.

Otherwise unless specified.



Other standards shall be based on JIS C 0806-1990.

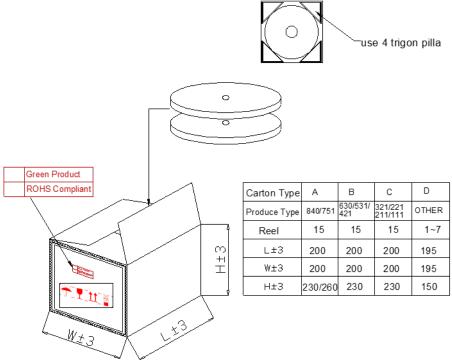
7. PACKAGE





HARMONY ELECTRONICS CORPRATION





- ①Top and bottom with 2.3cm thickness foam-rubber cushion for protection.
- ②Carton's Q'TY:1~15 pcs.
- ③Carton Type=A,B,C use 4 trigon pillar to fasten the Reel.
- 4Need to add 3 pages dry agent in each outer box.

8. MECHANICAL PERFORMANCE

	Item	Test M	Specifications Code			
1	Shock	Dropping from 100 cm height 3 tim Refer to: JIS C 60068-2-32	Α			
2	Vibration	Frequency 10-55Hz, Sine Wave full 3 axes, 2 cycles and duration of 2 h Refer to: JIS C 60068-2-6/ MIL-HDB	A			
3	Leakage Test		Leak Rate 1.0x10 ⁻⁹ Pa-m³/sec. Max. Measured by Helium leak			
4	Solder ability	After applying ROSIN Flux, dipping for 3 ±0.5 sec. Refer to: JIS C 60068-2-20/ JIS C 60	in solder bath at 245deg.C ±5deg.C 068-2-58	В		
5	Bending Strength	Mount a sample on board. Apply Pressure to the center of board until it is bent to 3 mm and hold for 5 ±1 sec. Pressure speed: 0.5 mm/sec. Refer to: EIAJ ET-7403/ JIS C 60068-2-21	Pressure rod 20 R230 Board 45± 2 45± 2	A		

HARMONY ELECTRONICS CORPRATION

KAOHSIUNG TAIPEI THAILAND SHENZHEN



6	Adhesion	Mount a sample on the circuit board. Apply pressure vertically to the side of specimen attached to the circuit board with the pressure jig. Pressure: 5N for 10±1 sec. Refer to: EIAJ ET-7403 JIS C 60068-2-21	Scratch tool R0.5 Chip Cross section	С
7	Body strength	Apply pressure to the center of body with the R0.5 pressure jig. pressure :10N for 10±1sec Refer to: EIAJ ET-7403 JIS C 60068-2-21	Pressure rad R0.5 Chip L L L W	С

9. ENVIRONMENT PERFORMANCE

	Item	Test Methods	Specifications Code
1	Resistance of Soldering Heat	Performing as the following reflow: Refer to: JIS C 60068-2-58	А
2	Humidity	Temperature $60^{\circ}\text{C}\pm2^{\circ}\text{C}$, RH $90^{\sim}95\%$, duration of 240 hours. Back to room temperature first, then check the component after $1^{\sim}2$ hours. Refer to: JIS C $60068-2-3$	А
3	Storage in Low Temperature	-40deg.C ±2deg.C, duration of 240 hours. Back to the room temperature first, then check the component after 1~2 hours. Refer to: JIS C 60068-2-1	А
4	Storage in High Temperature	+85deg.C ±2deg.C, duration of 240 hours. Back to the room temperature first, then check the component after 1~2 hours. Refer to: JIS C 60068-2-2	A
5	Thermal shock	-55deg.C ±2deg.C (30min) ↔ +125deg.C ±2deg.C (30min) 25 cycles. And Temperature Increasing/reducing time ≤ 3mins. Back to the room temperature first, then check the component after 1~2 hours. Refer to: JIS C 0025	A

Specifications code	Specifications		
Α	FREQ. DRIFT: ± 5 ppm Max, RESISTANCE DRIFT: $\pm 15\%$ or 2Ω		
В	More than 90% of lead shall be covered by new solder.		
С	FREQ. DRIFT: ± 15 ppm Max, RESISTANCE DRIFT: $\pm 25\%$ or 10Ω		

HARMONY ELECTRONICS CORPRATION

KAOHSIUNG TAIPEI THAILAND SHENZHEN

FACTORY LOCATION HEAD OFFICE/TAIWAN FACTORY

NO.39, HUADONG RD., DALIAO DIST., DAFA INDUSTRIAL PARK, KAOHSIUNG CITY 831, TAIWAN.

CHINA FACTORY

JU YUAN INDUSTRIAL PARK, QIAO TANG ROAD, TANG WEI COMMUNITY, FUYONG, BAOAN DISTRICT, SHEN ZHEN CITY, CHINA (Post Code:518103).

THAILAND FACTORY

66MOO 5, KAONGU-BEOKPRAI RD., T.BEOKPRAI, A. BANPONG, RATCHABURI PROVINCE 70110, THAILAND.

SERVICE CENTER TAIPEI OFFICE

2F., NO.409, SEC.2, TIDING BLVD., NEIHU DISTRICT, TAIPEI CITY 114, TAIWAN TEL: 886-2-26588883 FAX: 886-2-26588683

CONTACT INFORMATION

E-MAIL: contactus@hele.com.tw



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Crystals category:

Click to view products by Harmony manufacturer:

Other Similar products are found below:

CS325S24000000ABJT 718-13.2-1 MC405 32.0000K-R3:PURE SN FC-135R 32.7680KF-A3 7A-40.000MAAE-T 7B-27.000MBBK-T FL2000085 9B-15.360MBBK-B 9C-7.680MBBK-T ASH7K-32.768KHZ AT-41.600MAGQ-T BTD1062E05A-513 LFXTAL066198Cutt 9C-14.31818MBBK-T FA-238 50.0000MB30X-K3 FC-12M 32.7680KA-AC3 SSPT7F-9PF20-R FX325BS-38.88EEM1201 LFXTAL065253Cutt LFXTAL066431Cutt XT9S20ANA14M7456 XT9SNLANA16M 646G-24-2 7A-24.576MBBK-T 7B-30.000MBBK-T WX26-32.768K-6PF 9B-14.31818MBBK-B CD1AM 7B-25.000MAAE-T 7A-14.31818MBBK-T 6504-202-1501 6526-202-1501 FA-118T 27.1200MB50P-K0 FC-135R 32.7680KA-A3 ABM12-104-37.400MHZT ABLS-10.000MHZ-D3W-T BTJ112E01E-513 BTJ722K01C-7067 BTL-20-513 TSX-3225 24.0000MF15X-AC TSX-3225 16.0000MF18X-AC BTJ120E02C BTL-12-513 7A-10.000MBBK-T 7A-11.0592MBBK-T ABM12-103-24.000MHZT CS325S25000000ABJT ABM3B-25.000MHZ-B2-X-T FC-135 32.7680KA-A5 FX0800015